



U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
AP	AA	4,749,347	06/07/88	Valavaara	425	135	10/21/86
TAP	AB	5,121,329	06/09/92	Crump	425 364	174.4 468	10/30/89
PR	AC	5,402,351	03/28/95	Batchelder, et al.	364	468	01/18/94
FR	AD	5,764,521	06/09/98	Batchelder, et al.	425	375 475.01	11/13/95
TP	AE	5,866,058	02/02/99	Batchelder, et al.	264	30 8 237	05/29/97
P	AF	5,9 3 9,008	08/17/99	Comb, et al.	264	308	01/26/98
	AG						
	AH						
	AI						

FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Class	Sub Class	Translation Yes No
AJ	J					
Al	ĸ					

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

TH	AL	Paper entitled "High Temperature Fused Deposition Modelling: An Experimental Study Focusing on Mod Materials", by F.K. Feenstra, from Time-Compression Technologies '98 Conference (October 13-14, 1998, Nottingham, U.K.).						
	AM							
	AN							
EXAMI	NER⁄	That I	DATE CONSIDERED:	9/13/03				

EXAMINER: Initial is citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.